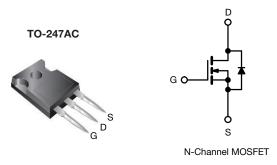
**Vishay Siliconix** 



### **E Series Power MOSFET**



PRODUCT SUMMA	RY	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850	)
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.25
Q <sub>g</sub> max. (nC)	122	2
Q <sub>gs</sub> (nC)	14	
Q <sub>gd</sub> (nC)	23	
Configuration	Sing	le

**FEATURES** 

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and halogen-free	SiHG17N80E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unle	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	800	v
Gate-source voltage			V <sub>GS</sub>	± 30	v
Continuous drain surrant $(T_{-} = 150 ^{\circ}\text{C})$	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	1	15	
Continuous drain current ( $T_J = 150 \ ^\circ C$ )	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	10	A
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	45	
Linear derating factor				1.7	W/°C
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	353	mJ
Maximum power dissipation			PD	208	W
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope T <sub>J</sub> = 125 °C		-15 / / -11	70	V/ns	
Reverse diode dV/dt <sup>d</sup>	•		dV/dt	5.1	v/ns
Soldering recommendations (peak temperature) <sup>c</sup>	For	10 s		300	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,\,I_{AS}$  = 5.0 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C

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## SiHG17N80E

Vishay Siliconix

THERMAL RESISTANCE RAT	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-		62			°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-		0.6			0/11	
SPECIFICATIONS (T_J = 25 $^\circ C, u$	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	0 V, I <sub>D</sub> = 2	250 µA	800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	1.08	-	V/°C
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$= V_{GS}, I_D =$	250 µA	2.0	-	4.0	V
			$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	IGSS		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zeve ante velte en ducia comunit		V <sub>DS</sub> =	= 800 V, V <sub>C</sub>	<sub>is</sub> = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 640 V	/, V <sub>GS</sub> = 0 \	/, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I	<sub>D</sub> = 8.5 A	-	0.25	0.29	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> =	= 8.5 A	-	8.7	-	S
Dynamic	•							
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$	1	-	2408	-	
Output capacitance	C <sub>oss</sub>		$V_{DS} = 100$	V,	-	81	-	1
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MH:	z	-	9	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>		(1. 400.)(		-	58	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{\rm DS} = 0$ V	/ to 480 V,	V <sub>GS</sub> = 0 V	-	296	-	
Total gate charge	Qg				-	61	122	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 8.5	A, V <sub>DS</sub> = 480 V	-	14	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	23	-	
Turn-on delay time	t <sub>d(on)</sub>				-	22	44	
Rise time	t <sub>r</sub>	Van -	480 V, I <sub>D</sub>	- 8 5 4	-	24	48	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	= 10 V, R <sub>g</sub> :	= 9.1 Ω	-	71	142	ns
Fall time	t <sub>f</sub>	1 7	5		-	26	52	1
Gate input resistance	R <sub>g</sub>	f = 1	MHz, ope	n drain	0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	۱ <sub>S</sub>	MOSFET sym showing the	bol		-	-	15	
Pulsed diode forward current	I <sub>SM</sub>	integral revers p - n junction			-	-	45	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 8.5 /	A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				-	416	832	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25$	$^{\circ}C, I_{F} = I_{S}$	= 8.5 A,	-	6.4	12.8	μC
Reverse recovery current	I <sub>RRM</sub>	ai/dt = 1	100 A/µs, \	$v_{\rm R} = 25  \rm V$	-	27	-	A
· · · · · · · · · · · · · · · · · · ·		1			I	1		

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

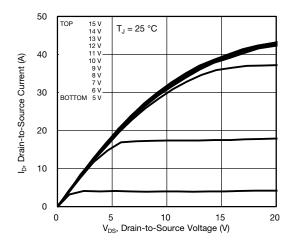
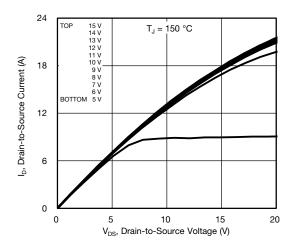
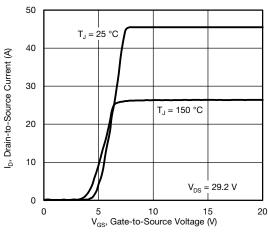


Fig. 1 - Typical Output Characteristics









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3.5 = 8.5 A R<sub>DS(on)</sub>, Drain-to-Source On-Resistance 3.0 2.5 (Normalized) 1.5 1.0 10 V = 0.5 0 -60 -40 -20 0 20 40 60 80 100 120 140 160 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

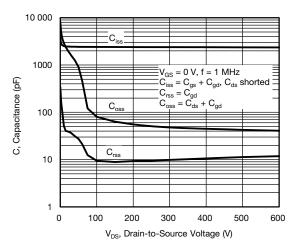


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

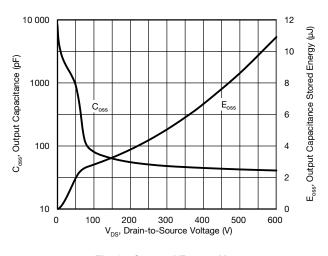


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 

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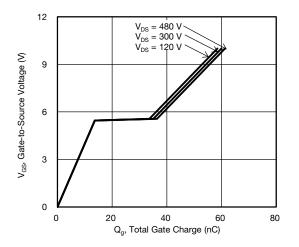


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

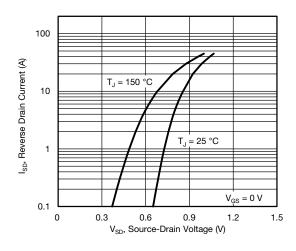


Fig. 8 - Typical Source-Drain Diode Forward Voltage

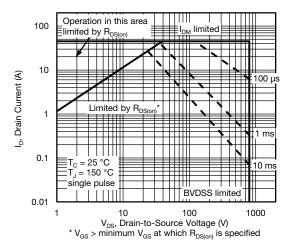


Fig. 9 - Maximum Safe Operating Area

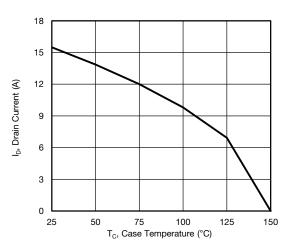


Fig. 10 - Maximum Drain Current vs. Case Temperature

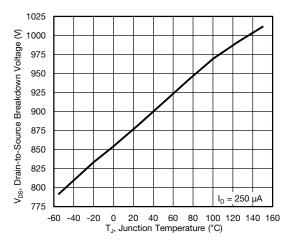


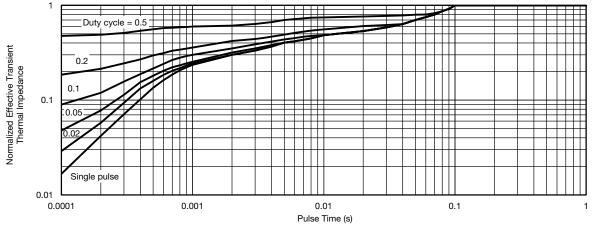
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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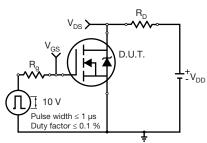


Fig. 13 - Switching Time Test Circuit

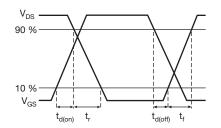


Fig. 14 - Switching Time Waveforms

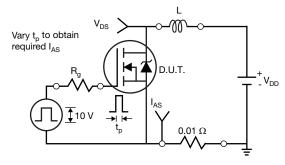


Fig. 15 - Unclamped Inductive Test Circuit

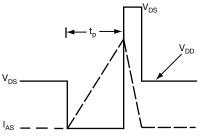


Fig. 16 - Unclamped Inductive Waveforms

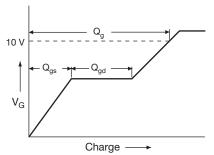


Fig. 17 - Basic Gate Charge Waveform

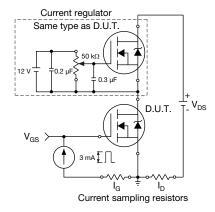


Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

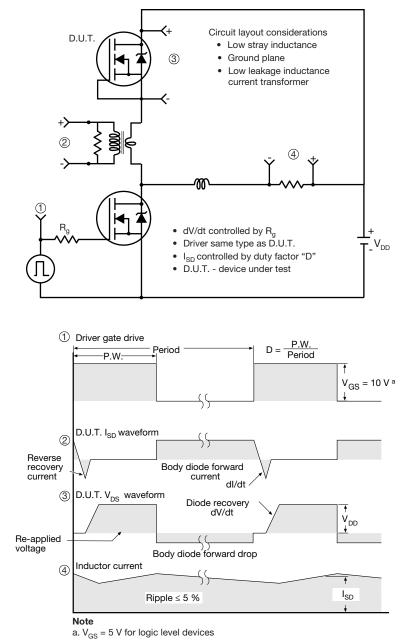


Fig. 19 - For N-Channel

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## TO-247AC (High Voltage)

### VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D1	16.25	16.85	5
D2	0.56	0.76	
E	15.50	15.87	4
E1	13.46	14.16	5
E2	4.52	5.49	3
е	5.44	BSC	
L	14.90	15.40	
L1	3.96	4.16	6
ØP	3.56	3.65	7
Ø P1	7.19	) ref.	
Q	5.31	5.69	
S	5.54	5.74	

#### Notes

- <sup>(1)</sup> Package reference: JEDEC<sup>®</sup> TO247, variation AC
- (2) All dimensions are in mm
- <sup>(3)</sup> Slot required, notch may be rounded
- <sup>(4)</sup> Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(5)</sup> Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition

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### VERSION 2: FACILITY CODE = Y



	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.58	5.31	
A1	2.21	2.59	
A2	1.17	2.49	
b	0.99	1.40	
b1	0.99	1.35	
b2	1.53	2.39	
b3	1.65	2.37	
b4	2.42	3.43	
b5	2.59	3.38	
с	0.38	0.86	
c1	0.38	0.76	
D	19.71	20.82	
D1	13.08	-	

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D2	0.51	1.30	
E	15.29	15.87	
E1	13.72	-	
е	5.46	BSC	
Øk	0.2	254	
L	14.20	16.25	
L1	3.71	4.29	
ØΡ	3.51	3.66	
Ø P1	-	7.39	
Q	5.31	5.69	
R	4.52	5.49	
S	5.51	BSC	

#### Notes

- <sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994
- <sup>(2)</sup> Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1
- <sup>(5)</sup> Lead finish uncontrolled in L1
- <sup>(6)</sup> Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- <sup>(7)</sup> Outline conforms to JEDEC outline TO-247 with exception of dimension c



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### VERSION 3: FACILITY CODE = N



	MILLIN	IETERS		MILLIN	IETERS
DIM.	MIN.	MAX.	DIM.	MIN.	MAX.
А	4.65	5.31	D2	0.51	1.35
A1	2.21	2.59	E	15.29	15.87
A2	1.17	1.37	E1	13.46	-
b	0.99	1.40	е	5.46	BSC
b1	0.99	1.35	k	0.:	254
b2	1.65	2.39	L	14.20	16.10
b3	1.65	2.34	L1	3.71	4.29
b4	2.59	3.43	N	7.62	BSC
b5	2.59	3.38	Р	3.56	3.66
С	0.38	0.89	P1	-	7.39
c1	0.38	0.84	Q	5.31	5.69
D	19.71	20.70	R	4.52	5.49
D1	13.08	-	S	5.51	BSC

Notes

<sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994

<sup>(2)</sup> Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

<sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1

<sup>(5)</sup> Lead finish uncontrolled in L1

<sup>(6)</sup> Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")



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